

# PC922

## High Power OPIC Photocoupler

\* Lead forming type (I type) and taping reel type (P type) are also available. (PC922I/PC922P) (Page 656)

### Features

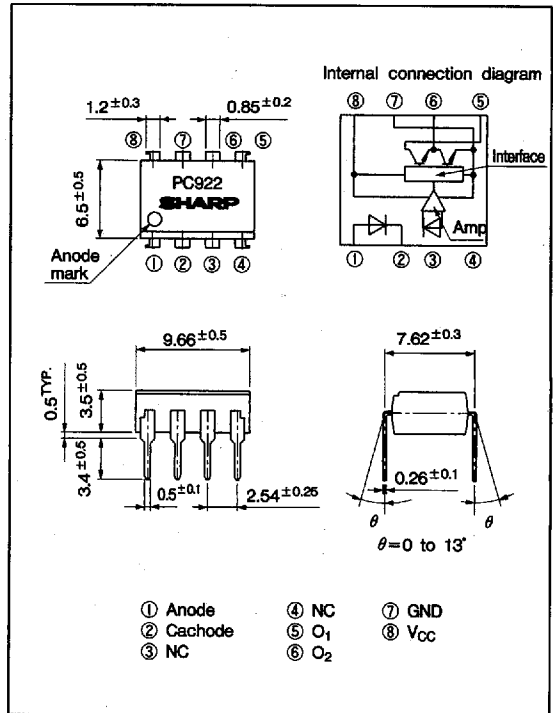
1. Built-in base amplifier for inverter drive
2. High power ( $I_{O1}$  : MAX. 0.5A(DC) )  
( $I_{O2P}$  : MAX. 2.0A(pulse) )
3. High isolation voltage between input and output ( $V_{iso}$  : 5 000V<sub>rms</sub>)
4. High noise reduction type
5. High speed response ( $t_{PHL}$ ,  $t_{PLH}$  : MAX. 5  $\mu$ s)
6. High sensitivity ( $I_{FLH}$  : MAX. 3mA)
7. Recognized by UL, file No. E64380

### Applications

1. Inverter controlled air conditioners
2. Small capacitance general purpose inverters

### Outline Dimensions

(Unit : mm)



\* "OPIC" (Optical IC) is a trademark of the SHARP Corporation.  
 An OPIC consists of a light-detecting element and signal-processing circuit integrated onto a single chip.

### Absolute Maximum Ratings (Ta = T<sub>opr</sub> unless otherwise specified)

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	25	mA
	*1 Reverse voltage	$V_R$	6	V
Supply voltage		$V_{CC}$	18	V
Output	O <sub>1</sub> output current	$I_{O1}$	0.5	A
	*2 O <sub>1</sub> peak output current	$I_{O1P}$	1.0	A
	O <sub>2</sub> output current	$I_{O2}$	0.6	A
	*2 O <sub>2</sub> peak output current	$I_{O2P}$	2.0	A
	O <sub>1</sub> output voltage	$V_{O1}$	18	V
	Power dissipation	$P_O$	500	mW
Total power dissipation		$P_{tot}$	550	mW
*3 Isolation voltage		$V_{iso}$	5 000	V <sub>rms</sub>
Operating temperature		$T_{opr}$	-20 to +80	°C
Storage temperature		$T_{stg}$	-55 to +125	°C
*4 Soldering temperature		$T_{sol}$	260	°C

\*1 Ta = 25°C

\*2 Pulse width  $\leq 5 \mu$ s, Duty ratio = 0.01

\*3 40 to 60%RH, AC for 1 minute, Ta = 25°C

\*4 For 10 seconds

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### ■ Electro-optical Characteristics

( $T_a = T_{opr}$  unless otherwise specified)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit	Fig.	
Input	Forward voltage	$V_{F1}$	$T_a = 25^\circ\text{C}$ , $I_F = 5\text{mA}$	—	1.1	1.4	V	—	
		$V_{F2}$	$T_a = 25^\circ\text{C}$ , $I_F = 0.2\text{mA}$	0.6	0.9	—	V	—	
	Reverse current	$I_R$	$T_a = 25^\circ\text{C}$ , $V_R = 3\text{V}$	—	—	10	$\mu\text{A}$	—	
	Terminal capacitance	$C_t$	$T_a = 25^\circ\text{C}$ , $V = 0$ , $f = 1\text{kHz}$	—	30	250	$\text{pF}$	—	
Operating supply voltage		$V_{CC}$		5.4	—	13	V	—	
Output	$O_1$ low level output voltage	$V_{O1L}$	$V_{CC} = 6\text{V}$ , $I_{O1} = 0.4\text{A}$ , $R_{L2} = 10\Omega$ , $I_F = 5\text{mA}$	—	0.2	0.4	V	1	
	$O_2$ high level output voltage	$V_{O2H}$	$V_{CC} = 6\text{V}$ , $I_{O2} = -0.4\text{A}$ , $I_F = 5\text{mA}$	4.5	5.0	—	V	2	
	$O_2$ low level output voltage	$V_{O2L}$	$V_{CC} = 6\text{V}$ , $I_{O2} = 0.5\text{A}$ , $I_F = 0$	—	0.2	0.4	V	—	
	$O_1$ leak current	$I_{O1L}$	$V_{CC} = 13\text{V}$ , $I_F = 0$	—	—	200	$\mu\text{A}$	3	
	$O_2$ leak current	$I_{O2L}$	$V_{CC} = 13\text{V}$ , $I_F = 5\text{mA}$	—	—	200	$\mu\text{A}$	4	
	High level supply current	$I_{CCH}$	$T_a = 25^\circ\text{C}$ , $V_{CC} = 6\text{V}$ , $I_F = 5\text{mA}$	—	9	13	$\text{mA}$	—	
			$V_{CC} = 6\text{V}$ , $I_F = 5\text{mA}$	—	—	17	$\text{mA}$	—	
	Low level supply current	$I_{CCL}$	$T_a = 25^\circ\text{C}$ , $V_{CC} = 6\text{V}$ , $I_F = 0$	—	11	15	$\text{mA}$	—	
$V_{CC} = 6\text{V}$ , $I_F = 0$			—	—	20	$\text{mA}$	—		
Transfer characteristics	*5 "Low→High" threshold input current	$I_{FLH}$	$T_a = 25^\circ\text{C}$ , $V_{CC} = 6\text{V}$ , $R_{L1} = 5\Omega$ , $R_{L2} = 10\Omega$	0.3	1.5	3.0	$\text{mA}$	5	
			$V_{CC} = 6\text{V}$ , $R_{L1} = 5\Omega$ , $R_{L2} = 10\Omega$	0.2	—	5.0	$\text{mA}$	5	
	Isolation resistance	$R_{ISO}$	$T_a = 25^\circ\text{C}$ , DC=500V 40 to 60%RH	$5 \times 10^{10}$	$10^{11}$	—	$\Omega$	—	
	Response time	"Low→High" propagation delay time	$t_{PLH}$	$T_a = 25^\circ\text{C}$ , $V_{CC} = 6\text{V}$ , $I_F = 5\text{mA}$ , $R_{L1} = 5\Omega$ , $R_{L2} = 10\Omega$	—	2	5	$\mu\text{s}$	6
		"High→Low" propagation delay time	$t_{PHL}$		—	2	5	$\mu\text{s}$	
		Rise time	$t_r$		—	0.2	1	$\mu\text{s}$	
		Fall time	$t_f$		—	0.1	1	$\mu\text{s}$	
	Instantaneous common mode rejection voltage "Output : High level"	$CM_H$	$T_a = 25^\circ\text{C}$ , $V_{CM} = 600\text{V (peak)}$ , $I_F = 5\text{mA}$ , $R_{L1} = 470\Omega$ , $R_{L2} = 1\text{k}\Omega$ , $\Delta V_{O2H} = 0.5\text{V}$	-1 500	—	—	$\text{V}/\mu\text{s}$	7	
Instantaneous common mode rejection voltage "Output : Low level"	$CM_L$	$T_a = 25^\circ\text{C}$ , $V_{CM} = 600\text{V (peak)}$ , $I_F = 0$ , $R_{L1} = 470\Omega$ , $R_{L2} = 1\text{k}\Omega$ , $\Delta V_{O2L} = 0.5\text{V}$	1 500	—	—	$\text{V}/\mu\text{s}$	7		

\*5  $I_{FLH}$  represents forward current when output goes from low to high.

### ■ Truth Table

Input	$O_2$ Output	Tr. 1	Tr. 2
ON	High level	ON	OFF
OFF	Low level	OFF	ON

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■ Test Circuit

Fig. 1

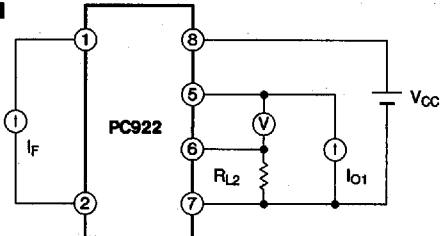


Fig. 3

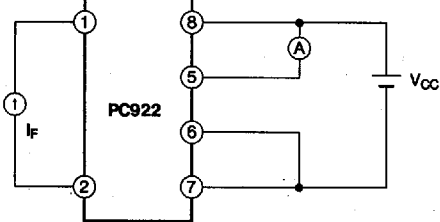


Fig. 5

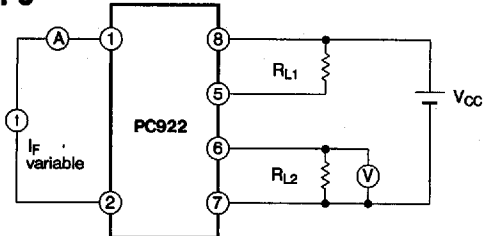


Fig. 7

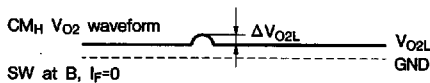
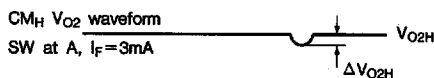
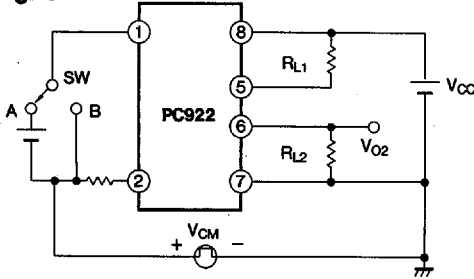


Fig. 2

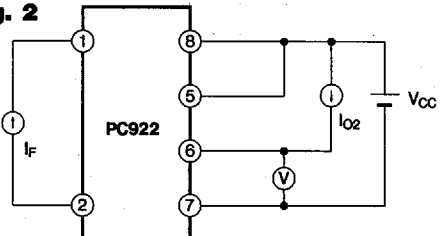


Fig. 4

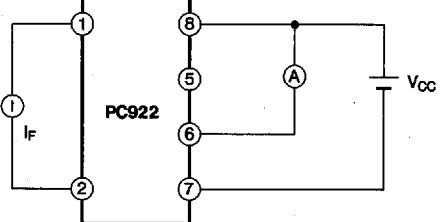


Fig. 6

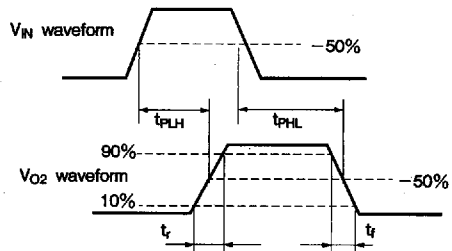
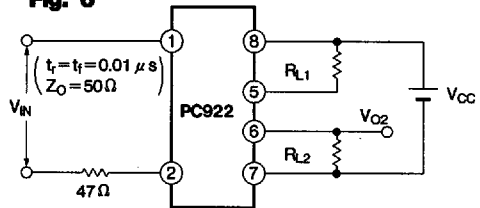
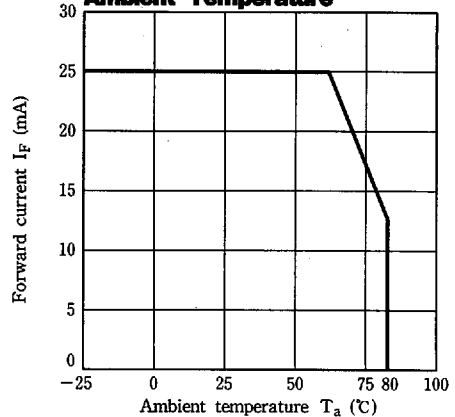
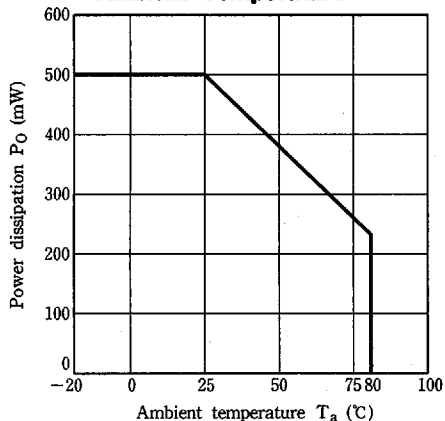


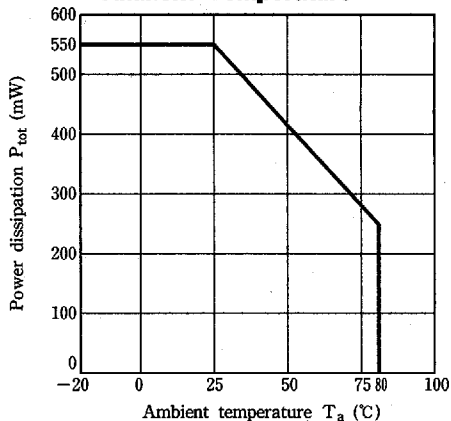
Fig. 8 Forward Current vs. Ambient Temperature



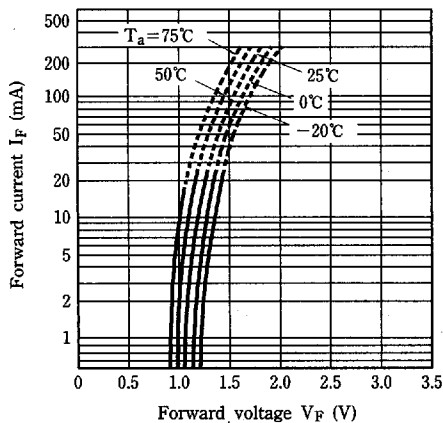
**Fig. 9-a Power Dissipation vs. Ambient Temperature**



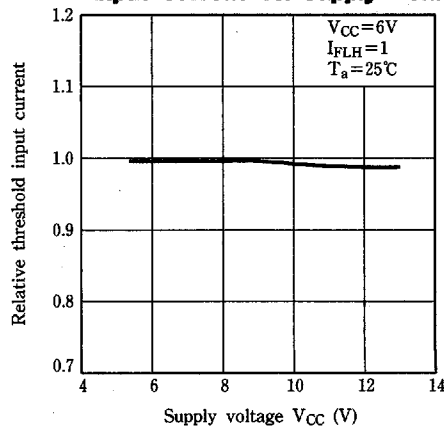
**Fig. 9-b Power Dissipation vs. Ambient Temperature**



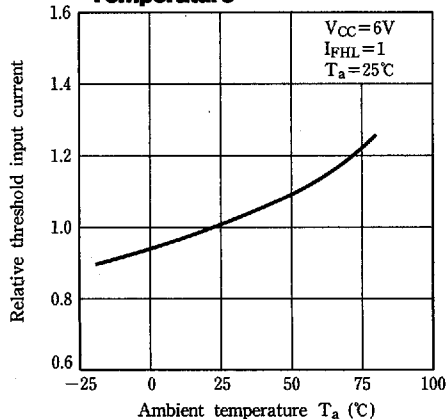
**Fig. 10 Forward Current vs. Forward Voltage**



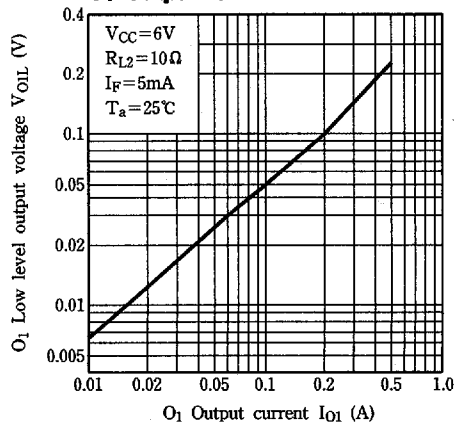
**Fig. 11 "Low → High" Relative Threshold Input Current vs. Supply Voltage**



**Fig. 12 "Low → High" Relative Threshold Input Current vs. Ambient Temperature**

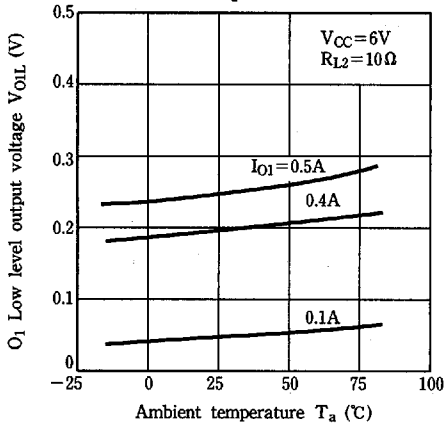


**Fig. 13 O<sub>1</sub> Low Level Output Voltage vs. O<sub>1</sub> Output Current**

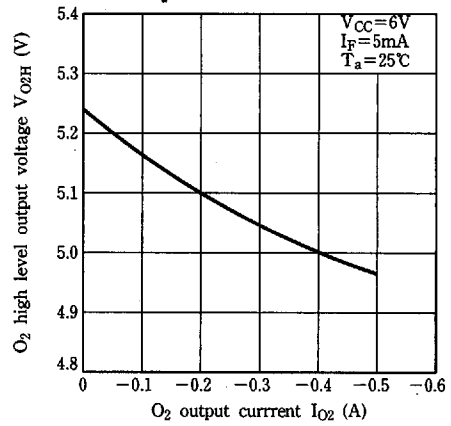


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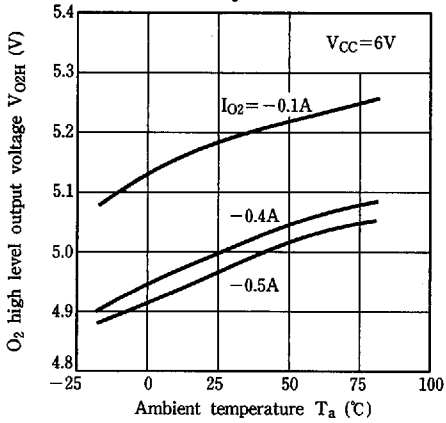
**Fig.14 O<sub>1</sub> Low Level Output Voltage vs. Ambient Temperature**



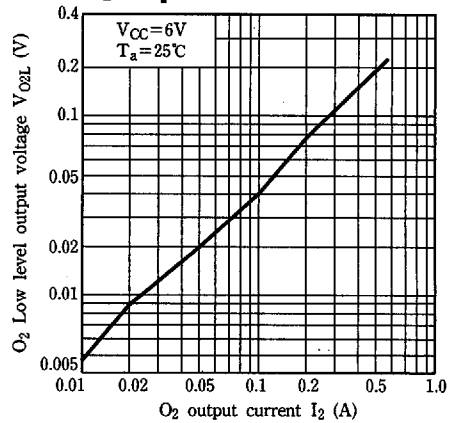
**Fig.15 O<sub>2</sub> High Level Output Voltage vs. O<sub>2</sub> Output Current**



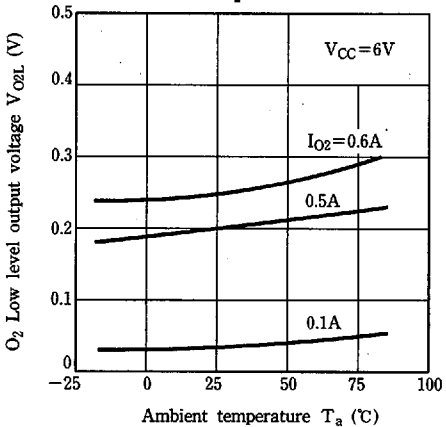
**Fig.16 O<sub>2</sub> High Level Output Voltage vs. Ambient Temperature**



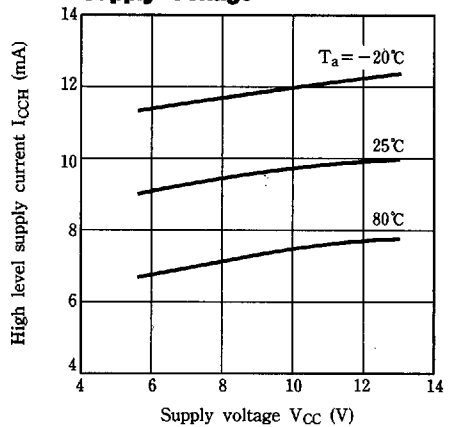
**Fig.17 O<sub>2</sub> Low Level Output Voltage vs. O<sub>2</sub> Output Current**



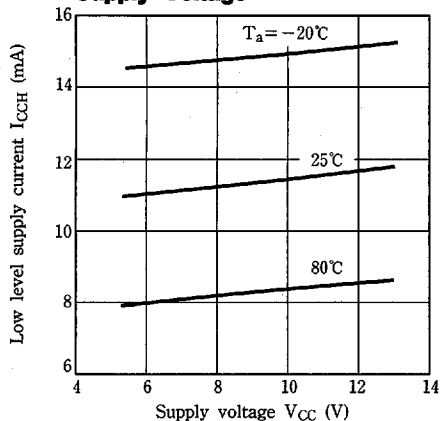
**Fig.18 O<sub>2</sub> Low Level Output Voltage vs. Ambient Temperature**



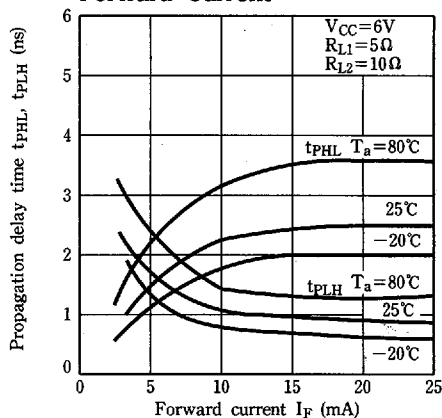
**Fig.19 High Level Supply Current vs. Supply Voltage**



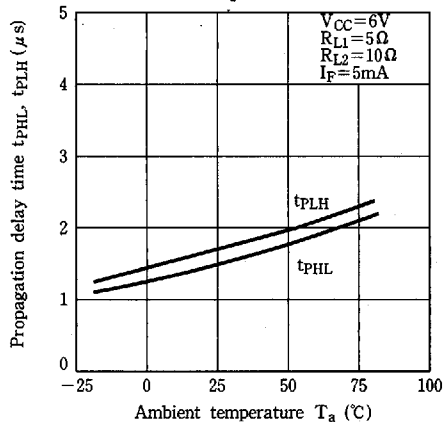
**Fig.20 Low Level Supply Current vs. Supply Voltage**



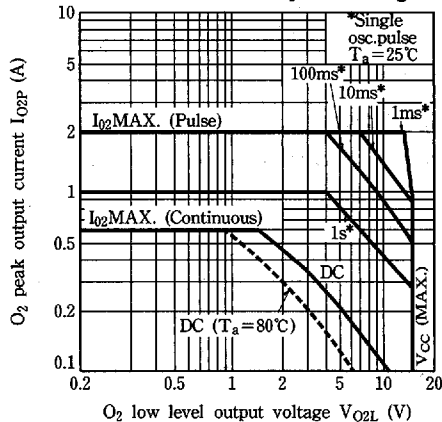
**Fig.21 Propagation Delay Time vs. Forward Current**



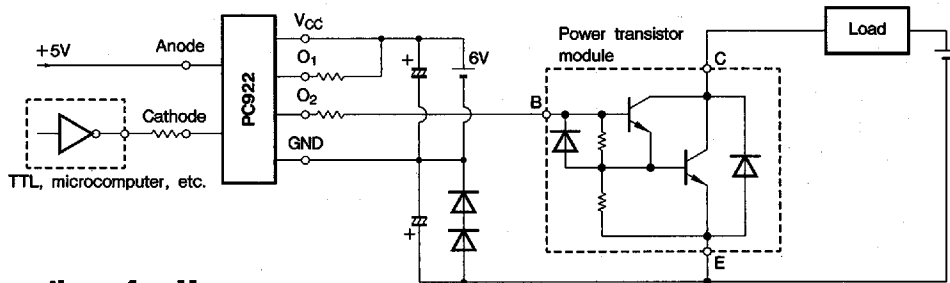
**Fig.22 Propagation Delay Time vs. Ambient Temperature**



**Fig.23 O<sub>2</sub> Peak Output Current vs. O<sub>2</sub> Low Level Output Voltage**



**Application Circuit**



**Precautions for Use**

- (1) It is recommended that a by-pass capacitor of more than  $0.01 \mu\text{F}$  is added between  $V_{CC}$  and GND near the device in order to stabilize power supply line.
- (2) Handle this product the same as with other integrated circuits against static electricity.
- (3) As for other general cautions, refer to the chapter "Precautions for Use" (Page 78 to 93)

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